

# DATA SHEET

**74LVC162373A;  
74LVCH162373A**

16-bit D-type transparent latch;  
30  $\Omega$  series termination resistors;  
5 V tolerant inputs/outputs; 3-state

Product specification  
Supersedes data of 1999 Aug 05

2004 Feb 05

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## 74LVC162373A; 74LVCH162373A

### FEATURES

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 to 3.6 V
- CMOS low power consumption
- MULTIBYTE flow-through standard pin-out architecture
- Low inductance multiple power and ground pins for minimum noise and ground bounce
- Direct interface with TTL levels
- All data inputs have bushold (74LVCH162373A only)
- High-impedance when  $V_{CC} = 0$  V
- Complies with JEDEC standard no. 8-1A
- ESD protection:  
HBM EIA/JESD22-A114-A exceeds 2000 V  
MM EIA/JESD22-A115-A exceeds 200 V.
- Specified from  $-40$  to  $+85$  °C and  $-40$  to  $+125$  °C.

### DESCRIPTION

The 74LVC(H)162373A is a 16-bit D-type transparent latch featuring separate D-type inputs for each latch and 3-state outputs for bus oriented applications. One latch enable (pin nLE) input and one output enable (pin n $\overline{OE}$ ) are provided for each octal. Inputs can be driven from either 3.3 or 5 V devices. In 3-state operation, outputs can handle 5 V. These features allow the use of these devices in a mixed 3.3 and 5 V environment.

The 74LVC(H)162373A consists of 2 sections of eight D-type transparent latches with 3-state true outputs. When pin nLE is HIGH, data at the corresponding data inputs (pins nDn) enter the latches. In this condition the latches are transparent, i.e., a latch output will change each time its corresponding data inputs changes.

When pin nLE is LOW the latches store the information that was present at the data inputs a set-up time preceding the HIGH-to-LOW transition of pin nLE. When pin n $\overline{OE}$  is LOW, the contents of the eight latches are available at the outputs. When pin n $\overline{OE}$  is HIGH, the outputs go to the high-impedance OFF-state. Operation of the n $\overline{OE}$  input does not affect the state of the latches.

The 74LVCH162373A bushold data inputs eliminates the need for external pull-up resistors to hold unused inputs.

The 74LVC(H)162373A is designed with 30  $\Omega$  series termination resistors in both high and low output stages to reduce line noise.

### QUICK REFERENCE DATA

GND = 0 V;  $T_{amb} = 25$  °C;  $t_r = t_f \leq 2.5$  ns

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
$t_{PHL}/t_{PLH}$	propagation delay nDn to nQn	$C_L = 50$ pF; $V_{CC} = 3.3$ V	3.3	ns
	propagation delay nLE to nQn	$C_L = 50$ pF; $V_{CC} = 3.3$ V	3.5	ns
$t_{PZH}/t_{PZL}$	3-state output enable time n $\overline{OE}$ to nQn	$C_L = 50$ pF; $V_{CC} = 3.3$ V	4.0	ns
$t_{PHZ}/t_{PLZ}$	3-state output disable time n $\overline{OE}$ to nQn	$C_L = 50$ pF; $V_{CC} = 3.3$ V	3.4	ns
$C_I$	input capacitance		5.0	pF
$C_{PD}$	power dissipation per latch	$V_{CC} = 3.3$ V; notes 1 and 2 outputs enabled	26	pF
		outputs disabled	19	pF

### Notes

1.  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu$ W).  
 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where:  
 $f_i$  = input frequency in MHz;  
 $f_o$  = output frequency in MHz;  
 $C_L$  = output load capacitance in pF;

16-bit D-type transparent latch; 30  $\Omega$  series termination resistors; 5 V tolerant inputs/outputs; 3-state

74LVC162373A;  
74LVCH162373A

$V_{CC}$  = supply voltage in Volts;

N = total load switching outputs;

$\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

2. The condition is  $V_I = \text{GND to } V_{CC}$ .

#### ORDERING INFORMATION

TYPE NUMBER	TEMPERATURE RANGE	PACKAGE			
		PINS	PACKAGE	MATERIAL	CODE
74LVC162373ADGG	-40 to +125 °C	48	TSSOP48	plastic	SOT362-1
74LVCH162373ADGG	-40 to +125 °C	48	TSSOP48	plastic	SOT362-1
74LVC162373ADL	-40 to +125 °C	48	SSOP48	plastic	SOT370-1
74LVCH162373ADL	-40 to +125 °C	48	SSOP48	plastic	SOT370-1

#### FUNCTION TABLE

Per section of eight bits; note 1

OPERATING MODES	INPUT			INTERNAL LATCH	OUTPUT nQn
	nOE	nLE	nDn		
Enable and read register (transparent mode)	L	H	L	L	L
	L	H	H	H	H
Latch and read register	L	L	l	L	L
	L	L	h	H	H
Latch register and disable outputs	H	L	l	L	Z
	H	L	h	H	Z

#### Note

- H = HIGH voltage level;  
h = HIGH voltage level one set-up time prior to the HIGH-to-LOW LE transition;  
L = LOW voltage level;  
l = LOW voltage level one set-up time prior to the HIGH-to-LOW LE transition;  
Z = high-impedance OFF-state.

16-bit D-type transparent latch; 30 Ω series termination resistors; 5 V tolerant inputs/outputs; 3-state

74LVC162373A;  
74LVCH162373A

**PINNING**

SYMBOL	PIN	DESCRIPTION
1OE	1	output enable input (active LOW)
1Q0	2	data output
1Q1	3	data output
GND	4, 10, 15, 21, 28, 34, 39, 45	ground (0 V)
1Q2	5	data output
1Q3	6	data output
V <sub>CC</sub>	7, 18, 31, 42	supply voltage
1Q4	8	data output
1Q5	9	data output
1Q6	11	data output
1Q7	12	data output
2Q0	13	data output
2Q1	14	data output
2Q2	16	data output
2Q3	17	data output
2Q4	19	data output
2Q5	20	data output
2Q6	22	data output
2Q7	23	data output
2OE	24	output enable input (active LOW)
2LE	25	latch enable input (active HIGH)
2D7	26	data input
2D6	27	data input
2D5	29	data input
2D4	30	data input
2D3	32	data input
2D2	33	data input
2D1	35	data input
2D0	36	data input
1D7	37	data input
1D6	38	data input
1D5	40	data input
1D4	41	data input
1D3	43	data input
1D2	44	data input

SYMBOL	PIN	DESCRIPTION
1D1	46	data input
1D0	47	data input
1LE	48	latch enable input (active HIGH)

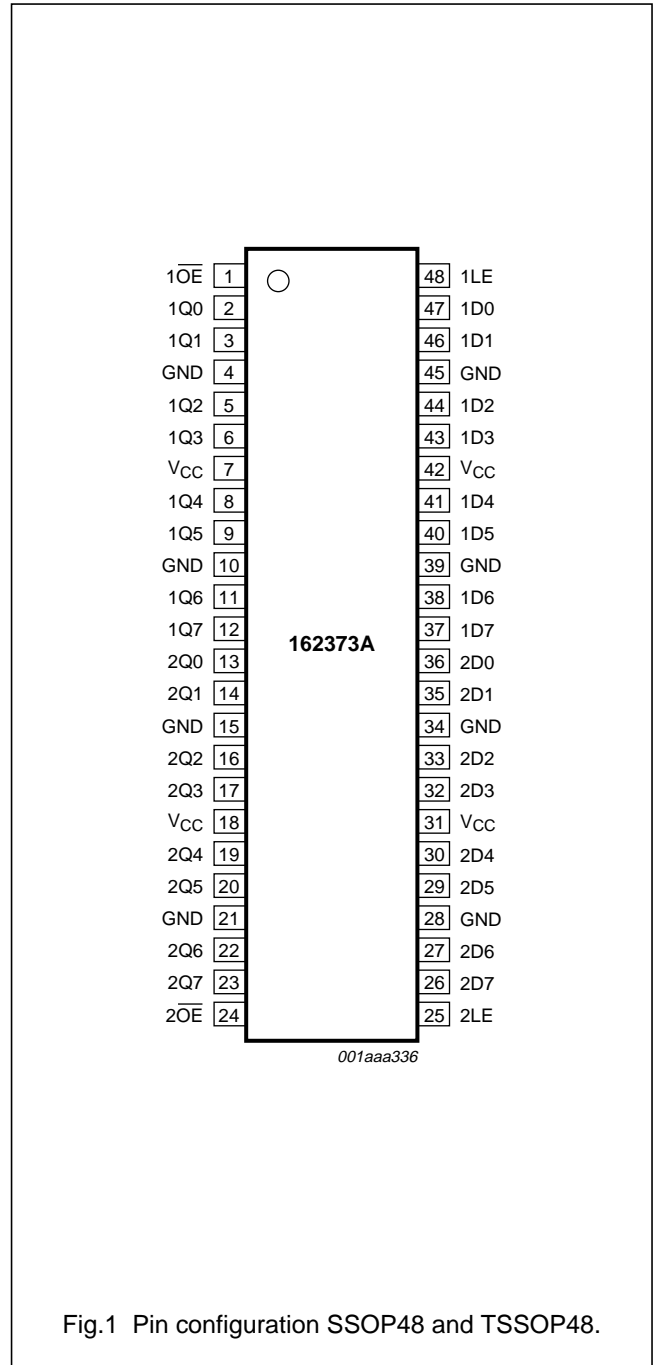


Fig.1 Pin configuration SSOP48 and TSSOP48.

16-bit D-type transparent latch; 30 Ω series termination resistors; 5 V tolerant inputs/outputs; 3-state

74LVC162373A;  
74LVCH162373A

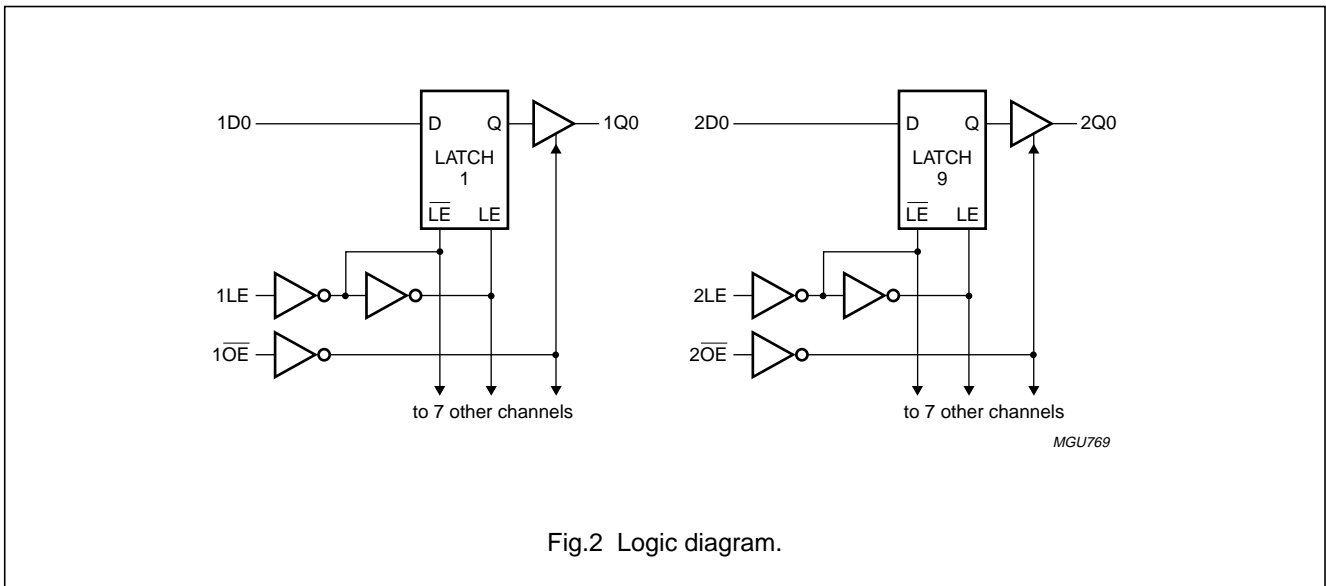


Fig.2 Logic diagram.

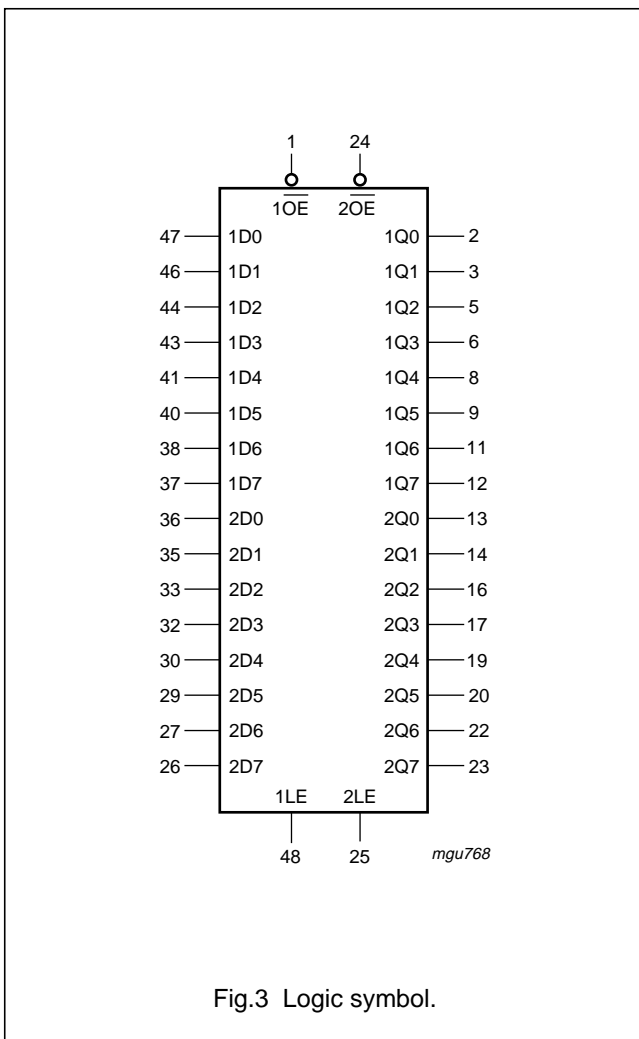


Fig.3 Logic symbol.

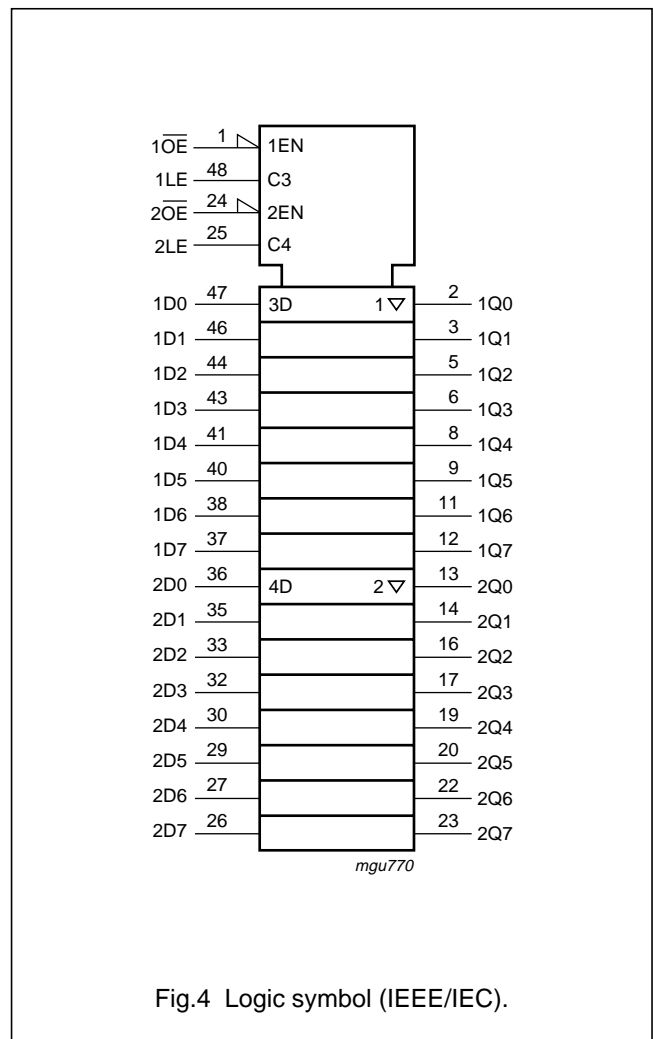


Fig.4 Logic symbol (IEEE/IEC).

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74LVC162373A;  
74LVCH162373A

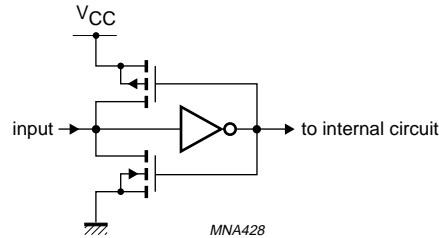


Fig.5 Bushhold circuit.

### RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CC</sub>	supply voltage	for maximum speed performance	2.7	3.6	V
		for low-voltage applications	1.2	3.6	V
V <sub>I</sub>	input voltage		0	5.5	V
V <sub>O</sub>	output voltage	output HIGH or LOW state	0	V <sub>CC</sub>	V
		output 3-state	0	5.5	V
T <sub>amb</sub>	operating ambient temperature	in free-air	-40	+125	°C
t <sub>r</sub> , t <sub>f</sub>	input rise and fall times	V <sub>CC</sub> = 1.2 to 2.7 V	0	20	ns/V
		V <sub>CC</sub> = 2.7 to 3.6 V	0	10	ns/V

### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134); voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CC</sub>	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input diode current	V <sub>I</sub> < 0	-	-50	mA
V <sub>I</sub>	input voltage	note 1	-0.5	+6.5	V
I <sub>OK</sub>	output diode current	V <sub>O</sub> > V <sub>CC</sub> or V <sub>O</sub> < 0	-	±50	mA
V <sub>O</sub>	output voltage	output HIGH or LOW state; note 1	-0.5	V <sub>CC</sub> + 0.5	V
		output 3-state; note 1	-0.5	+6.5	V
I <sub>O</sub>	output source or sink current	V <sub>O</sub> = 0 to V <sub>CC</sub>	-	±50	mA
I <sub>CC</sub> , I <sub>GND</sub>	V <sub>CC</sub> or GND current		-	±100	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	power dissipation	T <sub>amb</sub> = -40 to +125 °C; note 2	-	500	mW

### Notes

- The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
- Above 60 °C the value of P<sub>tot</sub> derates linearly with 5.5 mW/K.

16-bit D-type transparent latch; 30  $\Omega$  series termination resistors; 5 V tolerant inputs/outputs; 3-state

74LVC162373A;  
74LVCH162373A

### DC CHARACTERISTICS

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		OTHER	V <sub>CC</sub> (V)				
<b>T<sub>amb</sub> = -40 to +85 °C; note 1</b>							
V <sub>IH</sub>	HIGH-level input voltage		1.2	V <sub>CC</sub>	–	–	V
			2.7 to 3.6	2.0	–	–	V
V <sub>IL</sub>	LOW-level input voltage		1.2	–	–	GND	V
			2.7 to 3.6	–	–	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>O</sub> = -100 $\mu$ A	2.7 to 3.6	V <sub>CC</sub> - 0.2	V <sub>CC</sub> <sup>(2)</sup>	–	V
		I <sub>O</sub> = -6 mA	2.7	V <sub>CC</sub> - 0.5	–	–	V
		I <sub>O</sub> = -12 mA	3.0	V <sub>CC</sub> - 0.8	–	–	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>O</sub> = 100 $\mu$ A	2.7 to 3.6	–	GND <sup>(2)</sup>	0.20	V
		I <sub>O</sub> = 6 mA	2.7	–	–	0.40	V
		I <sub>O</sub> = 12 mA	3.0	–	–	0.55	V
I <sub>LI</sub>	input leakage current	V <sub>I</sub> = 5.5 V or GND; note 3	3.6	–	$\pm$ 0.1	$\pm$ 5	$\mu$ A
I <sub>OZ</sub>	3-state output OFF-state current	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>O</sub> = 5.5 V or GND; note 3	3.6	–	$\pm$ 0.1	$\pm$ 5	$\mu$ A
I <sub>off</sub>	power-off leakage current	V <sub>I</sub> or V <sub>O</sub> = 5.5 V	0	–	$\pm$ 0.1	$\pm$ 10	$\mu$ A
I <sub>CC</sub>	quiescent supply current	V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0	3.6	–	0.1	20	$\mu$ A
$\Delta$ I <sub>CC</sub>	additional quiescent supply current per input pin	V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; I <sub>O</sub> = 0	2.7 to 3.6	–	5 <sup>(2)</sup>	500	$\mu$ A
I <sub>BHL</sub>	bushold LOW sustaining current	V <sub>I</sub> = 0.8 V; notes 4 and 5	3.0	75	–	–	$\mu$ A
I <sub>BHH</sub>	bushold HIGH sustaining current	V <sub>I</sub> = 2.0 V; notes 4 and 5	3.0	-75	–	–	$\mu$ A
I <sub>BHLO</sub>	bushold LOW overdrive current	notes 4 and 6	3.6	500	–	–	$\mu$ A
I <sub>BHNO</sub>	bushold HIGH overdrive current	notes 4 and 6	3.6	-500	–	–	$\mu$ A

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74LVC162373A;  
74LVCH162373A

SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		OTHER	V <sub>CC</sub> (V)				
<b>T<sub>amb</sub> = -40 to +125 °C</b>							
V <sub>IH</sub>	HIGH-level input voltage		1.2	V <sub>CC</sub>	–	–	V
			2.7 to 3.6	2.0	–	–	V
V <sub>IL</sub>	LOW-level input voltage		1.2	–	–	GND	V
			2.7 to 3.6	–	–	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>O</sub> = -100 $\mu$ A	2.7 to 3.6	V <sub>CC</sub> - 0.3	–	–	V
		I <sub>O</sub> = -6 mA	2.7	V <sub>CC</sub> - 0.65	–	–	V
		I <sub>O</sub> = -12 mA	3.0	V <sub>CC</sub> - 1	–	–	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>O</sub> = 100 $\mu$ A	2.7 to 3.6	–	–	0.3	V
		I <sub>O</sub> = 6 mA	2.7	–	–	0.6	V
		I <sub>O</sub> = 12 mA	3.0	–	–	0.8	V
I <sub>LI</sub>	input leakage current	V <sub>I</sub> = 5.5 V or GND; note 3	3.6	–	–	$\pm$ 20	$\mu$ A
I <sub>OZ</sub>	3-state output OFF-state current	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>O</sub> = 5.5 V or GND; note 3	3.6	–	–	$\pm$ 20	$\mu$ A
I <sub>off</sub>	power off leakage current	V <sub>I</sub> or V <sub>O</sub> = 5.5 V	0	–	–	$\pm$ 20	$\mu$ A
I <sub>CC</sub>	quiescent supply current	V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0	3.6	–	–	80	$\mu$ A
$\Delta$ I <sub>CC</sub>	additional quiescent supply current per input pin	V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; I <sub>O</sub> = 0	2.7 to 3.6	–	–	5000	$\mu$ A
I <sub>BHL</sub>	bushold LOW sustaining current	V <sub>I</sub> = 0.8 V; notes 4 and 5	3.0	60	–	–	$\mu$ A
I <sub>BHH</sub>	bushold HIGH sustaining current	V <sub>I</sub> = 2.0 V; notes 4 and 5	3.0	-60	–	–	$\mu$ A
I <sub>BHLO</sub>	bushold LOW overdrive current	notes 4 and 6	3.6	500	–	–	$\mu$ A
I <sub>BHHO</sub>	bushold HIGH overdrive current	notes 4 and 6	3.6	-500	–	–	$\mu$ A

#### Notes

1. All typical values are measured at T<sub>amb</sub> = 25 °C.
2. Measured at V<sub>CC</sub> = 3.3 V.
3. For bushold parts, the bushold circuit is switched off when V<sub>I</sub> > V<sub>CC</sub> allowing 5.5 V on the input pin.
4. Valid for data inputs of bushold parts (LVCH162373A) only. For data inputs only; control inputs do not have a bushold circuit.
5. The specified sustaining current at the data inputs holds the input below the specified V<sub>I</sub> level.
6. The specified overdrive current at the data input forces the data input to the opposite logic input state.



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74LVC162373A;  
74LVCH162373A

### AC CHARACTERISTICS

GND = 0 V;  $t_r = t_f \leq 2.5$  ns;  $C_L = 50$  pF;  $R_L = 500$   $\Omega$ .

SYMBOL	PARAMETER	CONDITIONS		MIN.	TYP.	MAX.	UNIT
		WAVEFORMS	V <sub>CC</sub> (V)				
<b>T<sub>amb</sub> = -40 to +85 °C; note1</b>							
t <sub>PHL</sub> /t <sub>PLH</sub>	propagation delay nDn to nQn	see Fig 6 and 10	1.2	–	12	–	ns
			2.7	1.5	–	6.7	ns
			3.0 to 3.6	1.0	3.3 <sup>(2)</sup>	5.9	ns
	propagation delay nLE to nQn	see Fig 7 and 10	1.2	–	14	–	ns
			2.7	1.5	–	7.0	ns
			3.0 to 3.6	1.5	3.5 <sup>(2)</sup>	6.1	ns
t <sub>PZH</sub> /t <sub>PZL</sub>	3-state output enable time $\overline{nOE}$ to nQn	see Fig 8 and 10	1.2	–	18	–	ns
			2.7	1.5	–	7.5	ns
			3.0 to 3.6	1.0	4.0 <sup>(2)</sup>	6.1	ns
t <sub>PHZ</sub> /t <sub>PLZ</sub>	3-state output disable time $\overline{nOE}$ to nQn	see Fig 8 and 10	1.2	–	11	–	ns
			2.7	1.5	–	4.8	ns
			3.0 to 3.6	1.5	3.4 <sup>(2)</sup>	4.6	ns
t <sub>W</sub>	nLE pulse width HIGH	see Fig 7	1.2	–	–	–	ns
			2.7	3.0	–	–	ns
			3.0 to 3.6	3.0	2.0 <sup>(2)</sup>	–	ns
t <sub>SU</sub>	set-up time nDn to nLE	see Fig 9	1.2	–	–	–	ns
			2.7	2.0	–	–	ns
			3.0 to 3.6	2.0	1.0 <sup>(2)</sup>	–	ns
t <sub>H</sub>	hold time nDn to nLE	see Fig 9	1.2	–	–	–	ns
			2.7	0.9	–	–	ns
			3.0 to 3.6	0.9	-1.0 <sup>(2)</sup>	–	ns
t <sub>sk(0)</sub>	skew	note 3	3.0 to 3.6	–	–	1.0	ns

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74LVCH162373A

SYMBOL	PARAMETER	CONDITIONS		MIN.	TYP.	MAX.	UNIT
		WAVEFORMS	V <sub>CC</sub> (V)				
<b>T<sub>amb</sub> = -40 to +125 °C</b>							
t <sub>PHL</sub> /t <sub>PLH</sub>	propagation delay nDn to nQn	see Fig 6 and 10	1.2	–	–	–	ns
			2.7	1.5	–	8.5	ns
			3.0 to 3.6	1.0	–	7.5	ns
	propagation delay nLE to nQn	see Fig 7 and 10	1.2	–	–	–	ns
			2.7	1.5	–	9.0	ns
			3.0 to 3.6	1.5	–	8.0	ns
t <sub>PZH</sub> /t <sub>PZL</sub>	3-state output enable time n $\overline{OE}$ to nQn	see Fig 8 and 10	1.2	–	–	–	ns
			2.7	1.5	–	9.5	ns
			3.0 to 3.6	1.0	–	8.0	ns
t <sub>PHZ</sub> /t <sub>PLZ</sub>	3-state output disable time n $\overline{OE}$ to nQn	see Fig 8 and 10	1.2	–	–	–	ns
			2.7	1.5	–	6.0	ns
			3.0 to 3.6	1.5	–	6.0	ns
t <sub>w</sub>	nLE pulse width HIGH	see Fig 7	1.2	–	–	–	ns
			2.7	3.0	–	–	ns
			3.0 to 3.6	3.0	–	–	ns
t <sub>su</sub>	set-up time nDn to nLE	see Fig 9	1.2	–	–	–	ns
			2.7	2.0	–	–	ns
			3.0 to 3.6	2.0	–	–	ns
t <sub>h</sub>	hold time nDn to nLE	see Fig 9	1.2	–	–	–	ns
			2.7	0.9	–	–	ns
			3.0 to 3.6	0.9	–	–	ns
t <sub>sk(0)</sub>	skew	note 3	3.0 to 3.6	–	–	1.5	ns

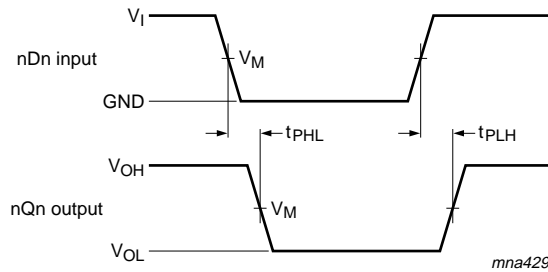
#### Notes

1. All typical values are measured at T<sub>amb</sub> = 25 °C.
2. Measured at V<sub>CC</sub> = 3.3 V.
3. Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

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74LVC162373A;  
74LVCH162373A

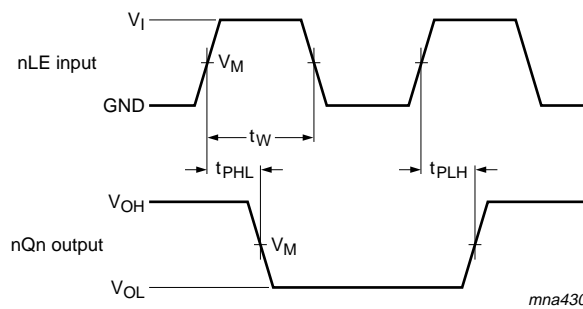
AC WAVEFORMS



V <sub>CC</sub>	V <sub>M</sub>	INPUT	
		V <sub>I</sub>	t <sub>r</sub> = t <sub>f</sub>
1.2 V	0.5 × V <sub>CC</sub>	V <sub>CC</sub>	≤ 2.5 ns
2.7 V	1.5 V	2.7 V	≤ 2.5 ns
3.0 to 3.6 V	1.5 V	2.7 V	≤ 2.5 ns

V<sub>OL</sub> and V<sub>OH</sub> are the typical output voltage drop that occur with the output load.

Fig.6 Input (nDn) to output (nQn) propagation delays.



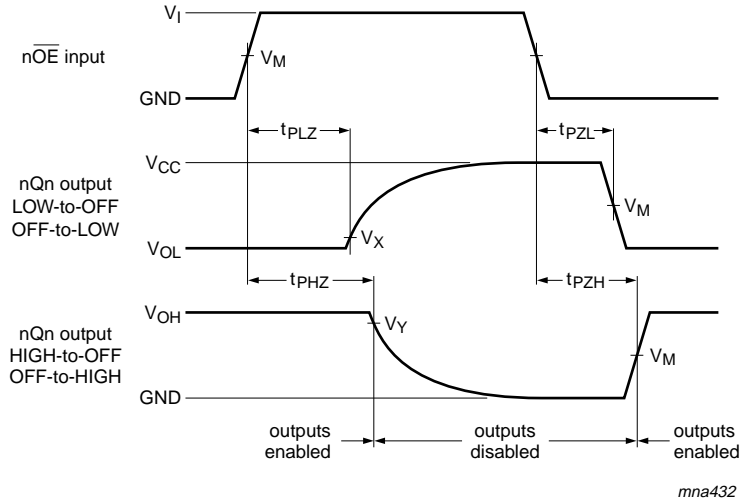
V <sub>CC</sub>	V <sub>M</sub>	INPUT	
		V <sub>I</sub>	t <sub>r</sub> = t <sub>f</sub>
1.2 V	0.5 × V <sub>CC</sub>	V <sub>CC</sub>	≤ 2.5 ns
2.7 V	1.5 V	2.7 V	≤ 2.5 ns
3.0 to 3.6 V	1.5 V	2.7 V	≤ 2.5 ns

V<sub>OL</sub> and V<sub>OH</sub> are the typical output voltage drop that occur with the output load.

Fig.7 Latch enable input (nLE) pulse width, and the latch enable input to output (nQn) propagation delays.

16-bit D-type transparent latch; 30 Ω series termination resistors; 5 V tolerant inputs/outputs; 3-state

74LVC162373A;  
74LVCH162373A

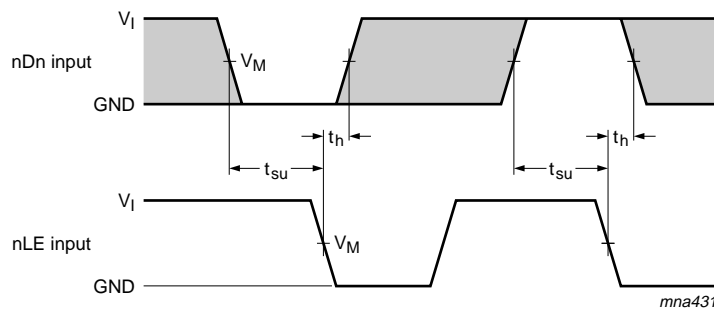


V <sub>CC</sub>	V <sub>M</sub>	INPUT	
		V <sub>I</sub>	t <sub>r</sub> = t <sub>f</sub>
1.2 V	0.5 × V <sub>CC</sub>	V <sub>CC</sub>	≤ 2.5 ns
2.7 V	1.5 V	2.7 V	≤ 2.5 ns
3.0 to 3.6 V	1.5 V	2.7 V	≤ 2.5 ns

V<sub>X</sub> = V<sub>OL</sub> + 0.3 V at V<sub>CC</sub> ≥ 2.7 V.  
 V<sub>X</sub> = V<sub>OL</sub> + 0.1V<sub>CC</sub> at V<sub>CC</sub> < 2.7 V.  
 V<sub>Y</sub> = V<sub>OH</sub> - 0.3 V at V<sub>CC</sub> ≥ 2.7 V.  
 V<sub>Y</sub> = V<sub>OH</sub> - 0.1V<sub>CC</sub> at V<sub>CC</sub> < 2.7 V.

V<sub>OL</sub> and V<sub>OH</sub> are the typical output voltage drop that occur with the output load.

Fig.8 3-state enable and disable times.



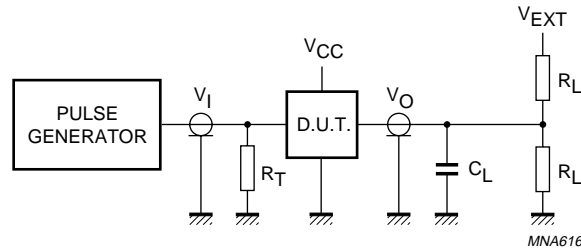
V <sub>CC</sub>	V <sub>M</sub>	INPUT	
		V <sub>I</sub>	t <sub>r</sub> = t <sub>f</sub>
1.2 V	0.5 × V <sub>CC</sub>	V <sub>CC</sub>	≤ 2.5 ns
2.7 V	1.5 V	2.7 V	≤ 2.5 ns
3.0 to 3.6 V	1.5 V	2.7 V	≤ 2.5 ns

The shaded areas indicate when the input is permitted to change for predictable performance.

Fig.9 Data set-up and hold times for the nDn input to the nLE input.

16-bit D-type transparent latch; 30 Ω series termination resistors; 5 V tolerant inputs/outputs; 3-state

74LVC162373A;  
74LVCH162373A



V <sub>CC</sub>	V <sub>I</sub>	C <sub>L</sub>	R <sub>L</sub>	V <sub>EXT</sub>		
				t <sub>PLH</sub> /t <sub>PHL</sub>	t <sub>PZH</sub> /t <sub>PHZ</sub>	t <sub>PZL</sub> /t <sub>PLZ</sub>
1.2 V	V <sub>CC</sub>	50 pF	500 Ω <sup>(1)</sup>	open	GND	2 × V <sub>CC</sub>
2.7 V	2.7 V	50 pF	500 Ω	open	GND	2 × V <sub>CC</sub>
3.0 to 3.6 V	2.7 V	50 pF	500 Ω	open	GND	2 × V <sub>CC</sub>

**Note**

1. The circuit performs better when R<sub>L</sub> = 1000 Ω.

Definitions for test circuit:

R<sub>L</sub> = Load resistor.

C<sub>L</sub> = Load capacitance including jig and probe capacitance.

R<sub>T</sub> = Termination resistance should be equal to the output impedance Z<sub>o</sub> of the pulse generator.

Fig.10 Load circuitry for switching times.

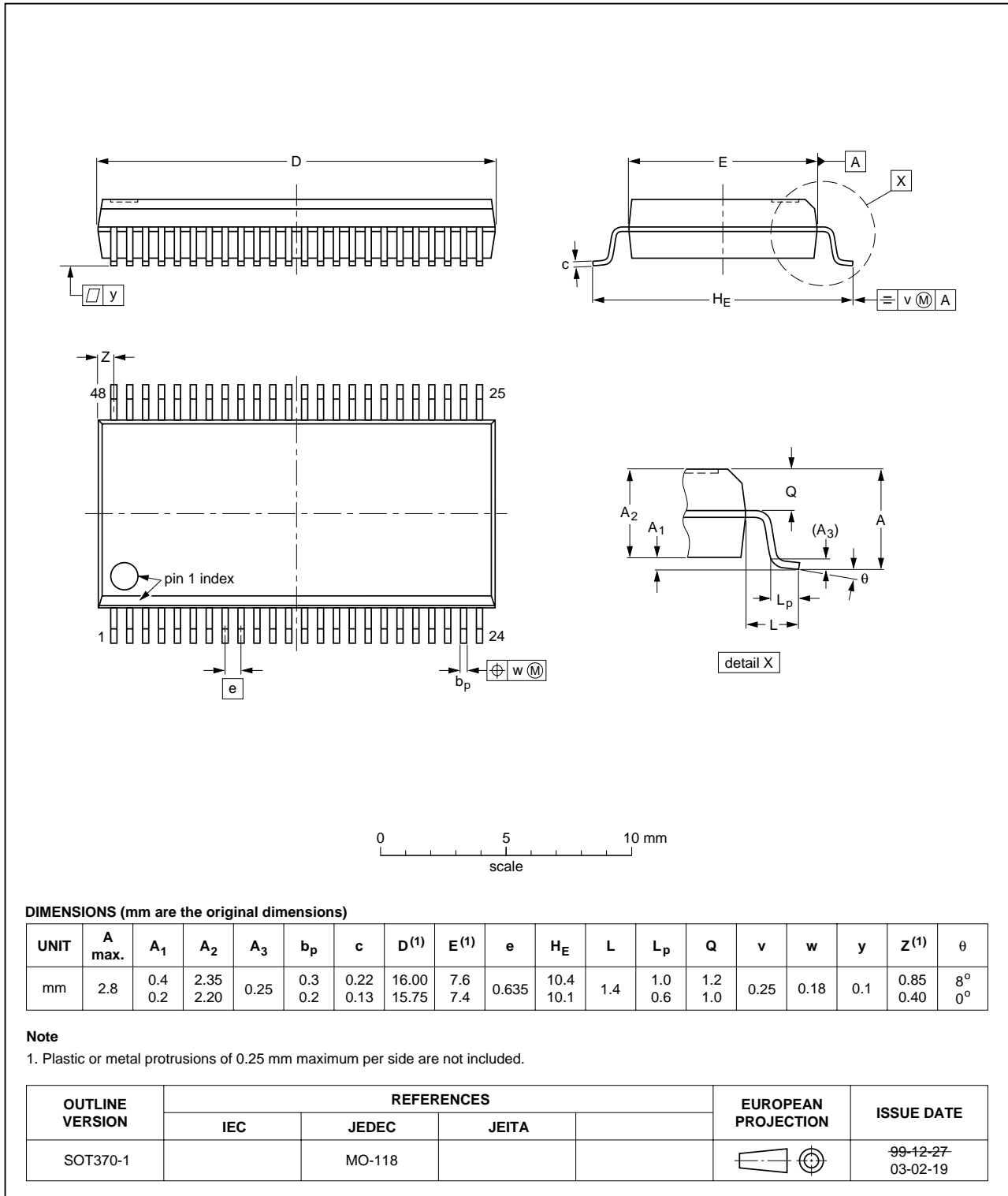
16-bit D-type transparent latch; 30 Ω series termination resistors; 5 V tolerant inputs/outputs; 3-state

74LVC162373A;  
74LVCH162373A

PACKAGE OUTLINES

SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1

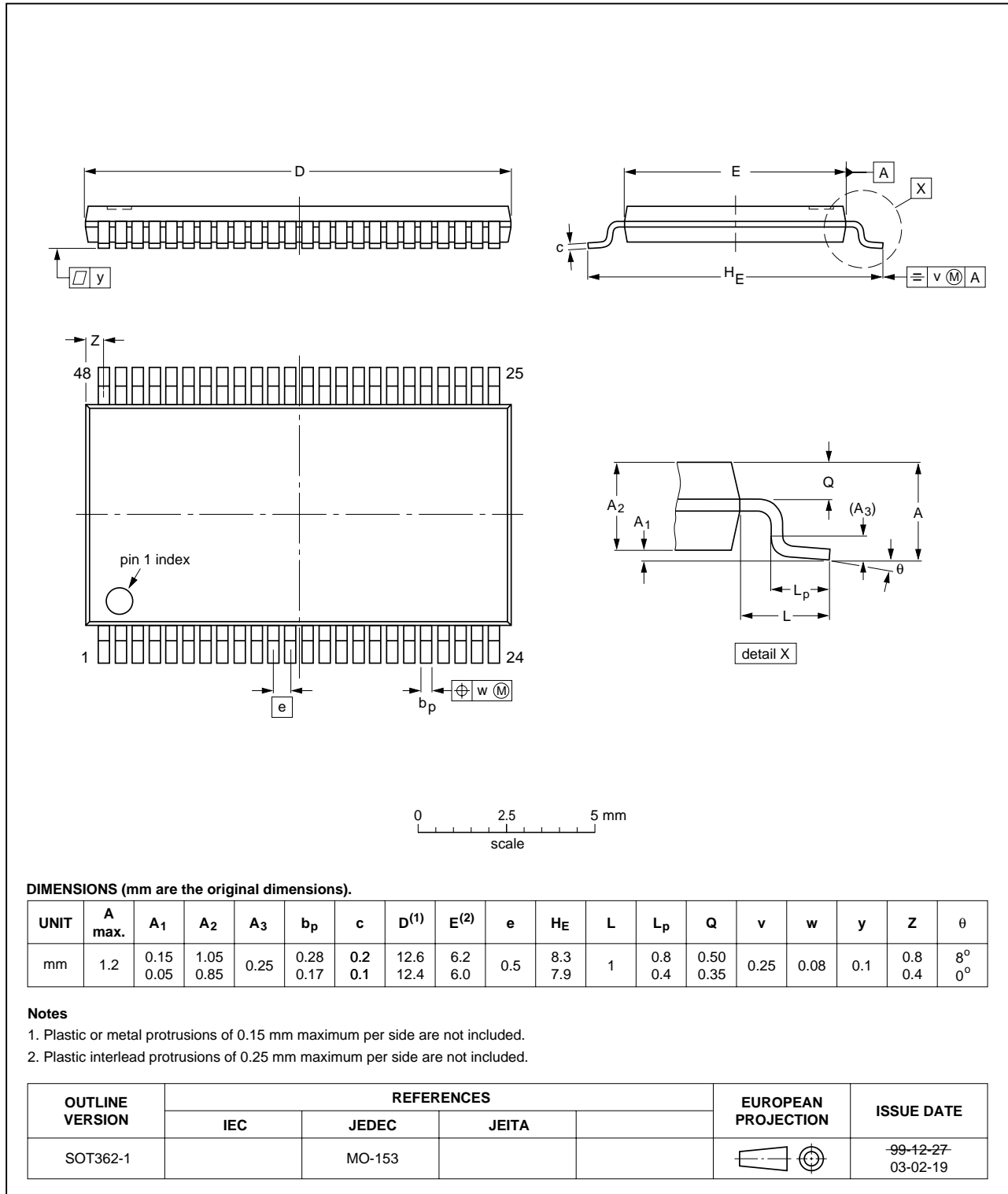


16-bit D-type transparent latch; 30 Ω series termination resistors; 5 V tolerant inputs/outputs; 3-state

74LVC162373A;  
74LVCH162373A

TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1 mm

SOT362-1



16-bit D-type transparent latch; 30  $\Omega$  series termination resistors; 5 V tolerant inputs/outputs; 3-state

74LVC162373A;  
74LVCH162373A

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LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)(3)</sup>	DEFINITION
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